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March 2015

∘C/W

### MTD3055V\*

#### **N-Channel Enhancement Mode Field Effect Transistor**

#### **General Description**

This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers.

These MOSFETs feature faster switching and lower gate charge than other MOSFETs with comparable  $R_{\rm DS(ON)}$  specifications.

The result is a MOSFET that is easy and safer to drive (even at very high frequencies), and DC/DC power supply designs with higher overall efficiency.

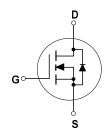
#### **Features**

- 12 A, 60 V.  $R_{DS(ON)}$  = 0.15  $\Omega$  @  $V_{GS}$  = 10 V
- · Low gate charge.
- · Fast switching speed.
- High performance technology for low  $R_{DS(ON)}$ .





Absolute Maximum Ratings Tc=25°C unless otherwise noted



Symbol	Parameter	Ratings	Units
V <sub>DSS</sub>	Drain-Source Voltage	60	V
V <sub>GSS</sub>	Gate-Source Voltage	±20	V
I <sub>D</sub>	Maximum Drain Current -Continuous (Note 1)	12	А
	T <sub>C</sub> = 100°C (Note 1)	7.3	
	Maximum Drain Current -Pulsed	37	
P <sub>D</sub>	Maximum Power Dissipation @ $T_c = 25^{\circ}C$ (Note 1)	48	W
	$T_A = 25^{\circ}C$ (Note 1a)	3.9	
	$T_A = 25^{\circ}C$ (Note 1b)	1.5	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range	-55 to +175	∘C

## Thermal Characteristics Reuse Thermal Resistance, Junction-to- Case (Note 1)

R <sub>eJA</sub>	Thermal Resistance, Junction-to- Ambient	(Note 1a)	38	∘C/W

Package Marking and Ordering Information

Device Marking	Device	Reel Size	Tape width	Quantity
MTD3055V	MTD3055V	13"	16mm	2500

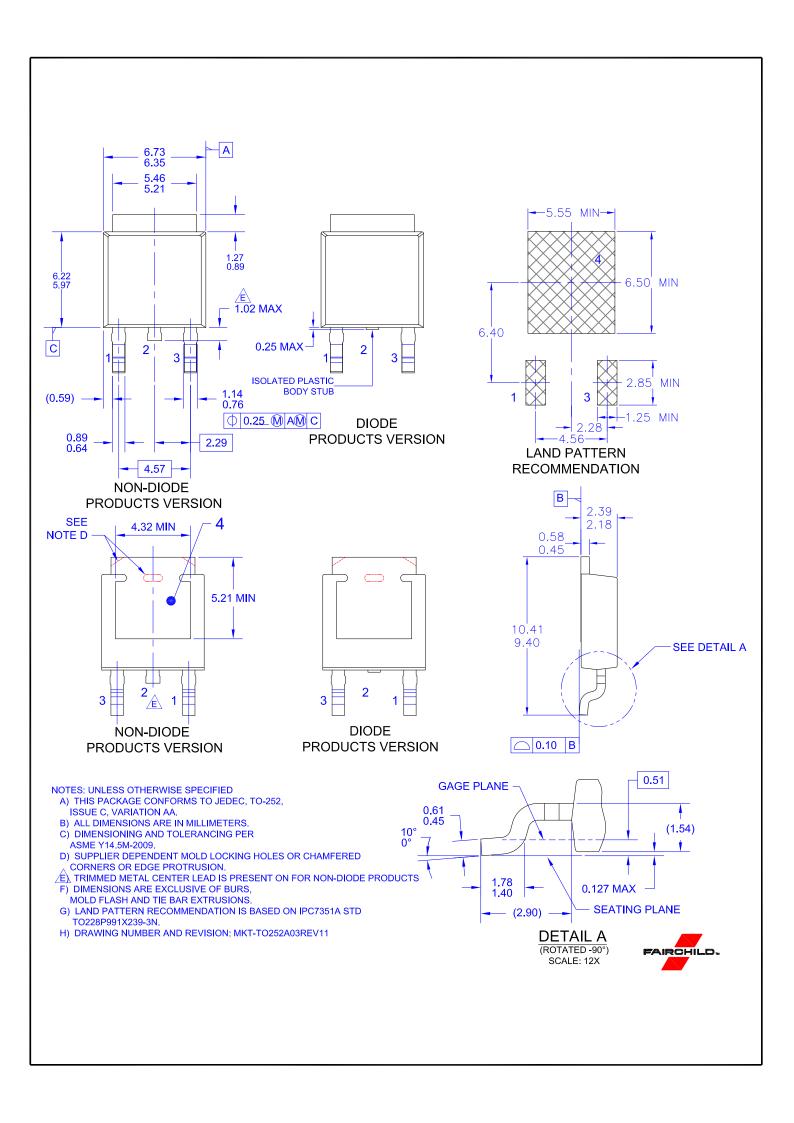
<sup>\*</sup> Die and manufacturing source subject to change without prior notification.

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
DRAIN-S	OURCE AVALANCHE RATI	NGS (Note 2)				•
W <sub>DSS</sub>	Single Pulse Drain-Source Avalanche Energy	V <sub>DD</sub> = 25 V <sub>1</sub> I <sub>D</sub> = 12 A			72	mJ
I <sub>AR</sub>	Maximum Drain-Source Avalanche	e Current			12	Α
Off Chara	acteristics					
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_{D} = 250  \mu\text{A}$	60			V
$\frac{\Delta^{BV t DSS}}{\Delta^{T t J}}$	Breakdown Voltage Temperature Coefficient	I <sub>D</sub> = 250 <sub>μ</sub> A, Referenced to 25°C		42		mV/∘C
IDSS	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 60 V, V <sub>GS</sub> = 0 V			10	μА
		V <sub>DS</sub> = 60 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 150°C			100	
GSSF	Gate-Body Leakage Current, Forward	V <sub>GS</sub> = 20 V, V <sub>DS</sub> = 0 V			100	nA
GSSR	Gate-Body Leakage Current, Reverse	V <sub>GS</sub> = -20 V, V <sub>DS</sub> = 0 V			-100	nA
On Chara	acteristics (Note 2)					
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{DS} = V_{GS}$ , $I_{D} = 250 \mu A$	2	2.8	4	V
$\frac{\Delta V^{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D$ = 250 $\mu$ A, Referenced to 25°C		-2.3		mV/∘C
R <sub>DS(on)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 6 A,			0.15	Ω
$V_{DS(on)}$	Drain-Source On-Voltage On-Resistance	V <sub>GS</sub> = 10 V <sub>1</sub>   <sub>D</sub> = 12 A V <sub>GS</sub> = 10 V <sub>1</sub>   <sub>D</sub> = 6 A <sub>1</sub> T <sub>J</sub> = 150∘C			2.2 1.9	V
<b>g</b> FS	Forward Transconductance	V <sub>DS</sub> = 7 V, I <sub>D</sub> = 6 A	4.0			S
Dynamic	Characteristics				,	•
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V,			500	pF
Coss	Output Capacitance	f = 1.0 MHz			180	pF
C <sub>rss</sub>	Reverse Transfer Capacitance				50	pF
Switchin	g Characteristics (Note 2)		•	•		•
t <sub>d(on)</sub>	Turn-On Delay Time	V <sub>DD</sub> = 30 V, I <sub>D</sub> = 12 A,			10	ns
tr	Turn-On Rise Time	$V_{GS}$ = 10 V, $R_{GEN}$ = 9.1 $\Omega$			60	ns
t <sub>d(off)</sub>	Turn-Off Delay Time				30	ns
t <sub>f</sub>	Turn-Off Fall Time				50	ns
Q <sub>g</sub>	Total Gate Charge	V <sub>DS</sub> = 48 V, I <sub>D</sub> = 12 A, V <sub>GS</sub> = 10 V		12.7	17	nC
Q <sub>gs</sub>	Gate-Source Charge			3.2		nC
Q <sub>qd</sub>	Gate-Drain Charge			7		nC
	urce Diode Characteristics	and Maximum Ratings		•	•	
Is	Maximum Continuous Drain-Sourc				12	А
I <sub>SM</sub>	Maximum Pulsed Drain-Source Did				37	Α
V <sub>SD</sub>	Drain-Source Diode Forward Voltage	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 12 A (Note 2)			1.6	V
t <sub>rr</sub>	Drain-Source Reverse Recovery Time	$I_F = 12 \text{ A}, \text{ di/dt} = 100 \text{A}/\mu\text{s}$		46		nS

<sup>1.</sup> R<sub>BJA</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the drain tab.  $R_{\theta JC}$  is guaranteed by design while  $R_{\theta CA}$  is determined by the user's board design.



Scale 1 : 1 on letter size paper 2. Pulse Test: Pulse Width ≤ 300 µs, Duty Cycle ≤ 2.0%



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